LITEON®

NB-IoT Module WNB303R

WNB303R(HV33): IO 3.3V

Compact-sized Multi-band With Ultra-low Power Consumption





NB-IoT Support

B1, B3, B5, B8, B20, B28



AT Commands



Extended Temperature Range: -40°C to +85°C



Ultra-Low Power Consumption

Advanced Solutions

WNB303R is high performance NB-IoT module with extremely low power consumption for long battery life up to 10 years. The ultra-low power design is applied at system level, in the different 3GPP modes of operation.

WNB303R supports various interfaces such as UART, I2C, SPI and so on. The module provides customer high flexibility for different kind of applications.

Due to the compact form factor, ultra-low power consumption and good performance, WNB303R is the best choice to be embedded to the design or solution for SmartX applications, ex. smart cities, smart metering and grid, security and asset tracking, environmental monitoring and control, health care monitoring, etc.

1.1. General Description

WNB303R is equipped with 40-pin 1.25mm pitch Stamp Pad of LCC package for PCB SMT mounting. The following chapters provide detailed descriptions of these pins:

- Power supply
- Reset interface
- UART interfaces
- USIM interface
- ADC interface
- I2C interface
- Status indication
- RF interface
- GPIO / SPI Interface*
- WAKEUP_IN / OUT Siganl

"*" means under development.

1.2. Pin Assignment

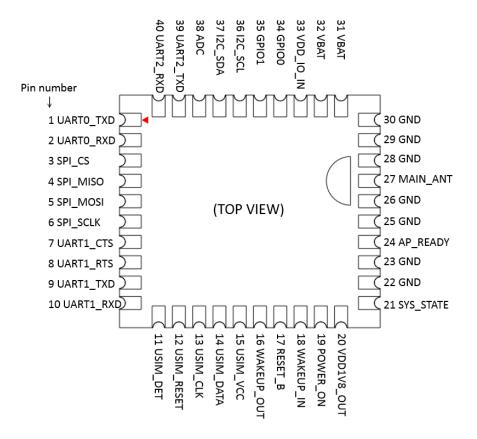


Figure.1 Pin Assignment

1.3. Pin Description

The following tables show the I/O parameters Definition of WNB303R. Please note all the adjustable I/O voltage of pins are under alignment.

| Туре | Description | | | |
|------|------------------------------|--|--|--|
| Ю | Bidirectional Input / Output | | | |
| DI | Digital Input | | | |
| DO | Digital Output | | | |
| PI | Power Input | | | |
| PO | Power Output | | | |
| AI | Analog Input | | | |
| AIO | Analog Input / Output | | | |
| GND | Ground | | | |
| | | | | |

Table 1: I/O Parameters Definition

Table 2: Pin Description

| Power Supply | | | | |
|--------------|-----------|-----|--------------------|----------------------|
| Pin Name | Pin No. | I/O | Description | Comment |
| | 31, 32 | PI | | For lower supply |
| | | | Power supply, | voltage as |
| VBAT | | | Voltage range: | 2.1~3.63V, please |
| VDAT | 51, 52 | ΓI | 2.6~5.5V | contact LITE-ON for |
| | | | Typ.: 3.8V | WNB302R NB-IoT |
| | | | | module. |
| | | | | Only used for level |
| | | | Supply voltage for | match, left |
| | | | external circuit. | unconnected when |
| VDD1V8_OUT | 20 | PO | VDD1V8_OUT = | not used. The |
| | | | default 1.8V | VDD1V8_OUT would |
| | | | lo MAX.=TBD | be off as working at |
| | | | | PSM mode. |
| | 22,23,25, | | | |
| GND | 26, 28, | GND | Ground | |
| | 29,30 | _ | | |
| | - , | | | |
| Power On/Off | | | | |

| Pin Name | Pin No. | I/O | Description | Comment | |
|----------------|---------|-------|--|---|--|
| POWER_ON | 19 | DI | Turn on/off the module | 3.3V power domain with Internally pulled up. Active low. (2.5V when PSM/Power off) | |
| RESET_B | 17 | DI | Reset the module | 3.3V power domain with Internally pulled up. Active low. (2.5V when PSM/Power off) | |
| | | Statu | is indication | | |
| Pin Name | Pin No. | I/O | Description | Comment | |
| SYS_STATE | 21 | DO | LED control output as network status indication. There are 4 frequency status: 1. (Light OFF) Power OFF 2. (10Hz) Module is powering on or SIM card is not available. 3. (5Hz) SIM card is available and searching the network 4. (1Hz) Online | Adjustable from 1.8 ~3.3V power domain with external IO circuit design. If unused, keep this pin open. | |
| UART Interface | | | | | |
| Pin Name | Pin No. | I/O | Description | Comment | |
| UART0_RXD | 2 | DI | Receive data | | |
| UART0_TXD | 1 | DO | Transmit data | Adjustable from | |
| UART1_RXD | 10 | DI | Receive data | 1.8 ~3.3V power | |
| UART1_TXD | 9 | DO | Transmit data | domain with external | |
| UART1_RTS | 8 | DO | Request to send | IO circuit design. | |
| UART1_CTS | 7 | DI | Clear to send | | |

| UART2_RXD | 40 | DI | Receive data | |
|--------------|---------|------|---|--|
| UART2_TXD | 39 | DO | Transmit data | |
| | | (U)S | IM Interface | |
| Pin Name | Pin No. | I/O | Description | Comment |
| USIM_VCC | 15 | PO | Power output for USIM card. Both 1.8V and 3V SIM Card is support. Output Voltage depends on SIM card types. Automatically switched. | All lines of USIM |
| USIM_RESET | 12 | DO | USIM card reset | protected with ESD component. |
| USIM_DATA | 14 | Ю | USIM Card data I/O with Internal pulled up | oomponont. |
| USIM_CLK | 13 | DO | USIM card clock | |
| USIM_DET | 11 | DI | USIM card detecting input | |
| | | AD | C Interface | |
| Pin Name | Pin No. | I/O | Description | Comment |
| ADC | 38 | AI | Analog to digital converter input. Voltage range: 0~1.4V. | External analog/sensor signal detection with 10bit accuracy. If unused, keep this pin open. |
| | | 120 | C Interface | |
| Pin Name | Pin No. | I/O | Description | Comment |
| I2C_SDA | 37 | Ю | I2C data input/output | Adjustable from 1.8 ~3.3V power domain with external |
| I2C_SCL | 36 | DO | I2C clock output | IO circuit design. Pull-up with external 2.2K resistance. If not used, keep them open. |
| RF Interface | | | | |

| Pin Name | Pin No. | I/O | Description | Comment |
|------------|---------|-----|--|-----------------------|
| | | | | Layout the 50ohm |
| MAIN_ANT | 27 | AIO | Main Antenna PAD | RF trace to Antenna |
| | | | | as short as possible. |
| | | SP | I interface | |
| Pin Name | Pin No. | I/O | Description | Comment |
| SPI_CS | 3 | DO | SPI segment | Adjustable from |
| SPI_MOSI | 5 | DO | SPI main output slave input | 1.8 ~3.3V power |
| SPI_SCLK | 6 | DO | SPI clock | domain with external |
| | | | SPI main input slave | IO circuit design. |
| SPI_MISO | 4 | DI | output | If unused, keep these |
| | | | | pins open. |
| | | GPI | O interface | |
| Pin Name | Pin No. | I/O | Description | Comment |
| GPIO0 | 34 | Ю | General purpose input | Adjustable from |
| | - | - | output | 1.8 ~3.3V power |
| | 35 | Ю | General purpose input output | domain with external |
| GPIO1 | | | | IO circuit design. |
| | | | | If unused, keep these |
| | | | | pins open. |
| | | 0 | ther Pins | |
| Pin Name | Pin No. | I/O | Description | Comment |
| | | | | Adjustable from |
| | 16 | DO | Output wakeup signal, wake up the external devices | 1.8 ~3.3V power |
| WAKEUP_OUT | | | | domain with external |
| | | | | IO circuit design. |
| | | | | Used for module to |
| | | | | wakeup MCU |
| | | | For external device to wakeup module | 3.3V power domain |
| WAKEUP_IN | 18 | DI | | (2.5V when |
| | | | | PSM/Power off |
| | | | | mode). Used for |
| | | | | MCU to wakeup |
| | | | | module. If module in |
| | | | | PSM status, Falling |

| | | | | edge can wakeup the |
|-----------|------|----|-----------|----------------------|
| | | | | module |
| | 04 | DI | Reserved. | Keep these pins |
| AP_READY | 24 | | | open |
| VDD_IO_IN | 33 P | DI | Reserved. | Adjustable from |
| | | | | 1.8 ~3.3V power |
| | | | | domain with external |
| | | | | IO circuit design. |

"*" means under development.

1.4. Mechanical Information

The following figure shows the package outline drawing of WNB303R .

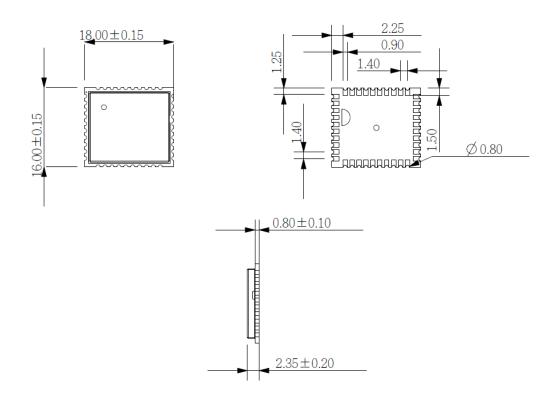


Figure.2 Dimensions (Unit: mm)

1.5. Recommended Footprint

The following figure shows the recommended Footprint of WNB303R.

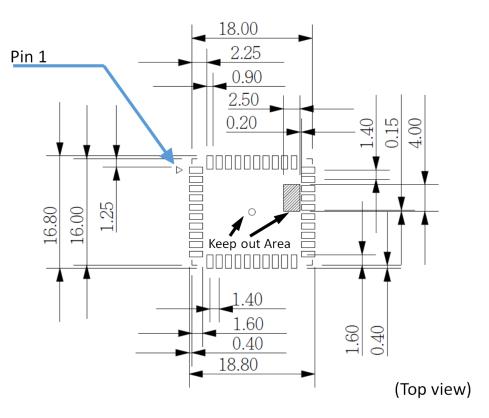


Figure3: Footprint recommendation (Unit: mm)

WNB303R *Under development or planning

- General Features
- Support 3GPP Rel14 NB-IoT air interfaces and protocols
- Support Band: B1, B3, B5, B8, B20, B28
- Output power: 23 dBm±2dB@ Class 3
- Sensitivity: -115dBm±1dBm @ QPSK
- Control Via AT Commands
- Temperature range: -40°C to +85°C
- Supply voltage: 2.6V to 5.5V, Typ.:3.8V
- IO voltage: 1.8V(default) or adjustable with externally supplied I/O voltage
- Power consumption: 2.8uA @ PSM

Other Features

- Support firmware update via UART and FOTA
- Support DRX/eDRX/PSM in the different 3GPP modes of operation

Interface

3xUART | I2C | SPI | USIM with 1.8V/3V operation | ADC | GPIO

Protocol Stacks

IPv4 | IPv6 | NON-IP | UDP | TCP | CoAP | (D)TLS | LWM2M | MQTT | HTTP(S)

Certifications

CE* | FCC* | CCC* | CTA* | GCF* | TELEC | JATE | NCC | RoHS Compliant

Package

- Low profile and Compact Form Factor: 18.0 x 16.0 x 2.35 mm
- Weight: 1.3g
- 40 Pin Stamp Pad of LCC package

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